

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

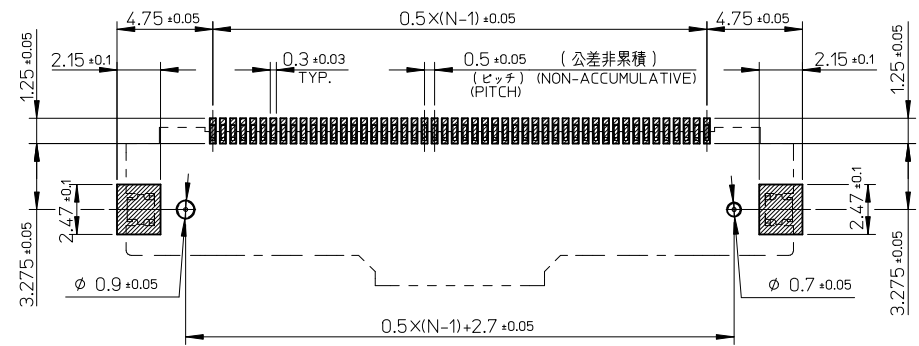
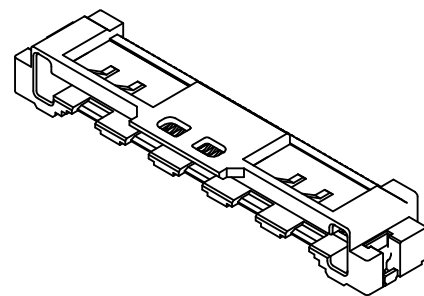
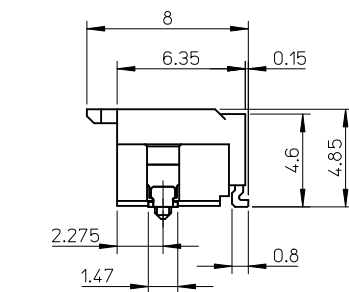
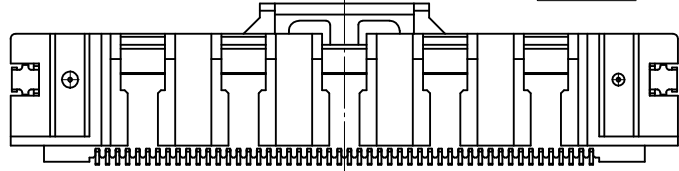
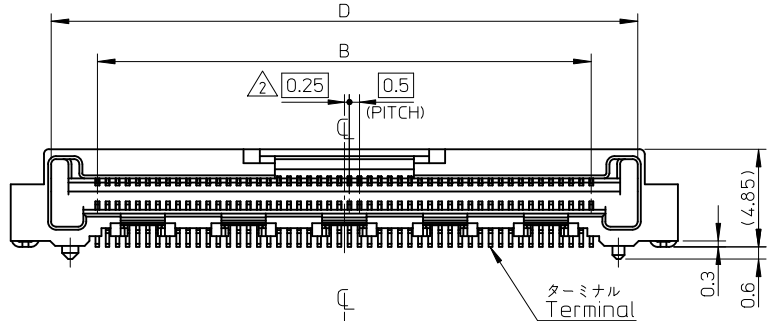
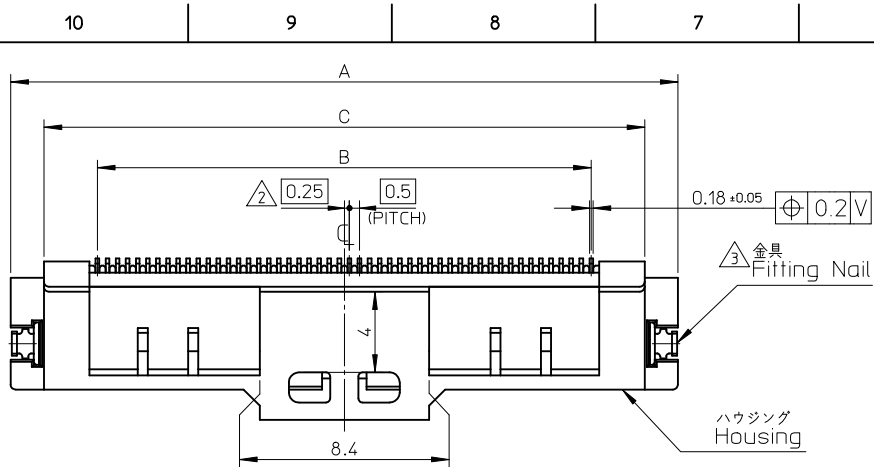


Contact us

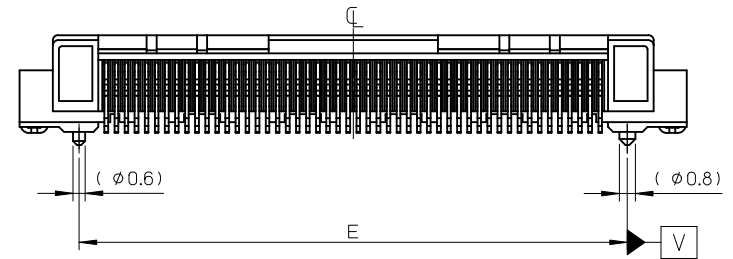
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



参考基板レイアウト
P.C. BOARD PATTERN
DIMENSION(REF.)
(マウント面)
(MOUNTING SIDE)



注記 1. 使用材料
NOTE MATERIAL

ハウジング
HOUSING

: 液晶ポリマー (LCP), ガラス充填,
UL94V-0 色: 黒色
LIQUID CRYSTAL POLYMER(LCP),
GLASS FILLED,UL94V-0 COLOR:BLACK

ターミナル
TERMINAL

: 銅合金 (t=0.18)
ニッケル下地 金メッキ (コンタクト、テール部)
COPPER ALLOY(t=0.18)
GOLD PLATING(CONTACT, TAIL AREA) OVER NICKEL PLATING.

金具
FITTING NAIL

: 銅合金 (t=0.25)
ニッケル下地 錫メッキ
COPPER ALLOY(t=0.25)
TIN OVER NICKEL PLATING.

△ N=偶数に通用 (N:極数)
APPLY FOR N=EVEN(CIRCUIT)

△ 3 パターン剥離止め用金具
FITTING NAIL FOR PREVENTION OF PEELING OF P.C.B PATTERN.

△ 適合ジャケット: 501783-**09
製品詳細寸法はSD-501783-001を参照下さい。
APPLICABLE JACKET:501783-**09.RE DETAILED DIMENSION,SEE SD-501783-001.

△ 5 適合ジャケットカバー: 501784-**09
製品詳細寸法はSD-501784-001を参照下さい。
APPLICABLE JACKET:501784-**09.RE DETAILED DIMENSION,SEE SD-501784-001.

6. ELV及びRoHS適合品
ELV AND RoHS COMPLIANT

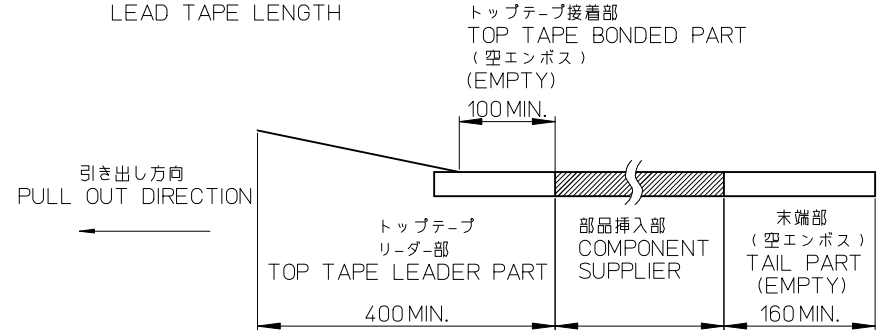
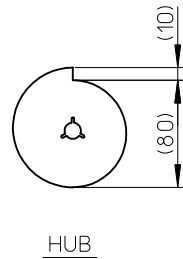
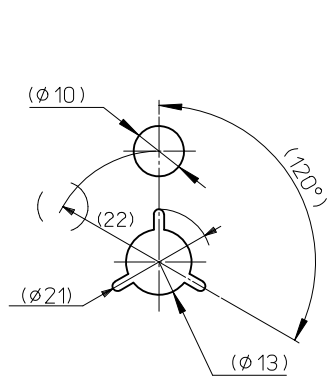
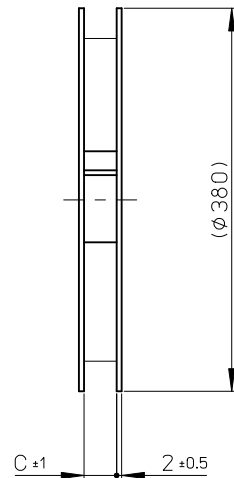
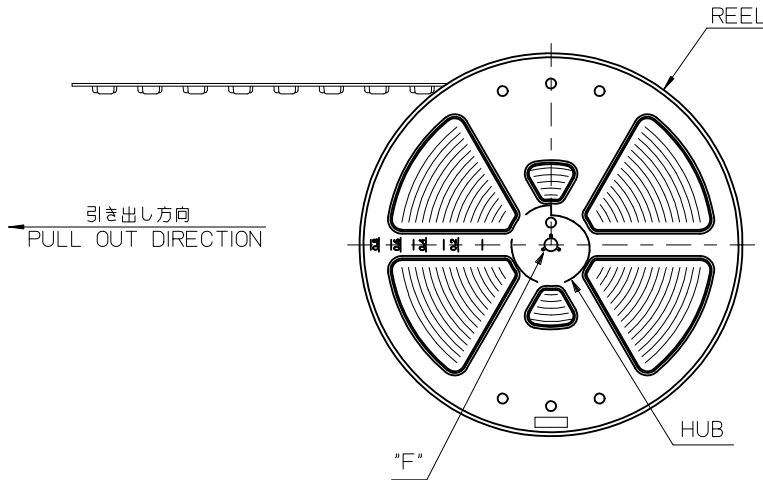
42.2	44.1	44.8	39.5	48.1	501864-8090	80	
27.2	29.1	29.8	24.5	33.1	501864-5090	50	
E	D	C	B	A	EMBOSSED PACKAGE	極数	
CONNECTION SERIES NO. 501864-**11						オーダー番号 ORDER NO.	CIRCUITS

REVISED	EC NO. J2010-1937	2010/03/25	DRWN:YMORI	2010/03/25	CHKD:MIATSUURA	2010/05/10	APPR:KMORIKAWA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)
A									10 UNDER ±0.2
									10 OVER 30 UNDER ±0.25
									30 OVER ±0.3
									ANGULAR ±1 °
									DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

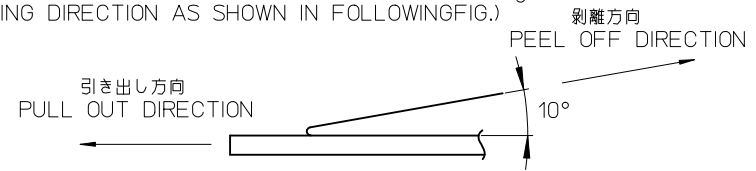
DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
DRAWN BY H. IJIMA	DATE 06/01/13	TITLE 0.5 FFC TO BOARD CONN REC. HSG ASSY(RA)		
CHECKED BY K. TAKAHASHI	DATE 06/01/13	MOLEX INCORPORATED		
APPROVED BY H. HIRATA	DATE 06/01/13			
MATERIAL NO. 501864-**11	DOCUMENT NO. SD-501864-001	SHEET NO. 1 OF 2		
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

NOTES

- 極包数量：900 個/リール
NUMBER OF CONNECTORS:900 PCS/REEL
- リードテープ長さ
LEAD TAPE LENGTH



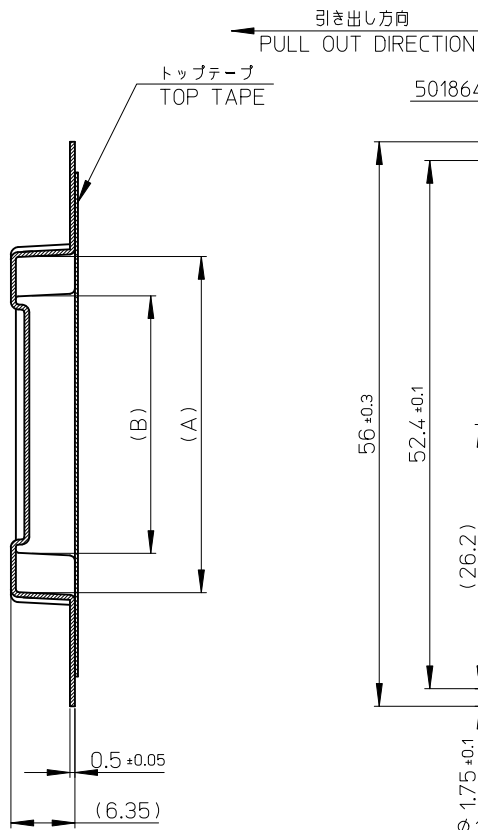
- トップテープの剥離強度：0.1~1.27N(10~130gf)
(剥離方向は下図参照)
剥離速度：300mm/MIN.(参考)
PEEL-OFF FORCE OF TOP TAPE : 0.1~1.27N(10~130gf)
(PEELING DIRECTION AS SHOWN IN FOLLOWINGFIG.)



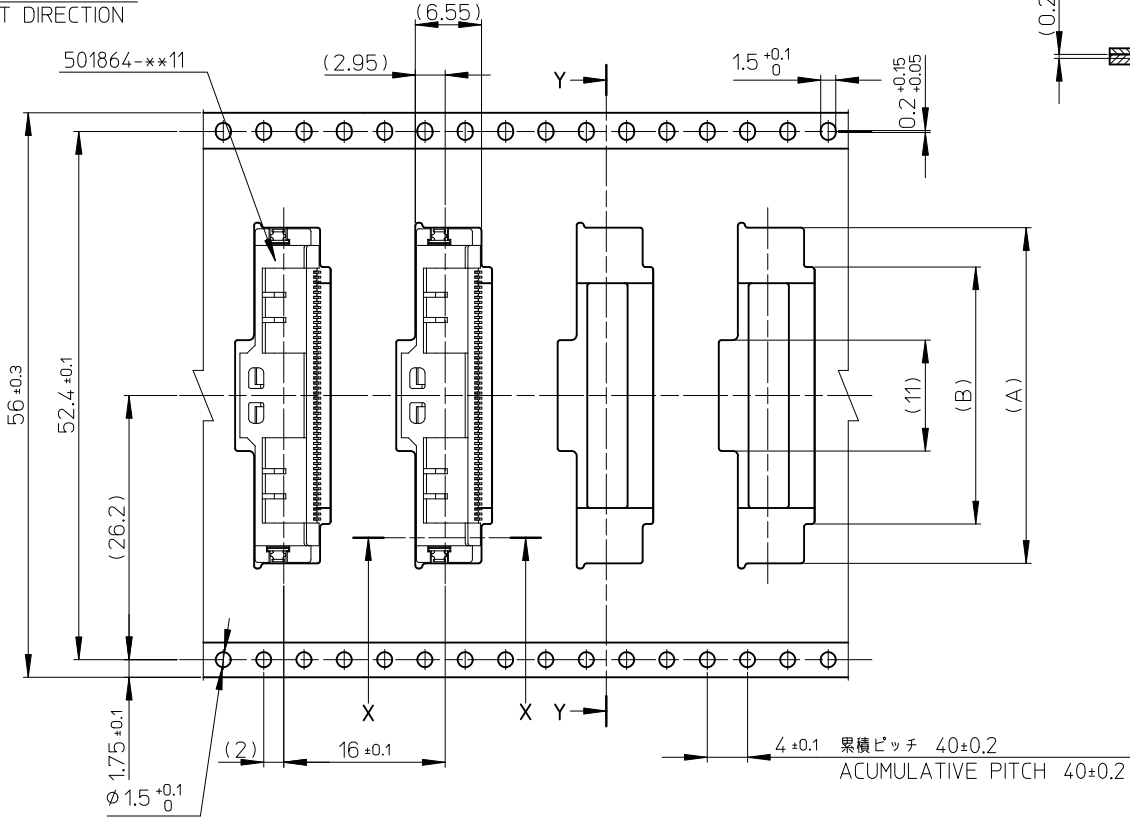
- 製品詳細寸法については図面 SD-501864-001を参照下さい。
RE DETAILED DIMENSION, SEE SD-501864-001.
- 材料(MATERIAL)
キャリアテープ(CARRIER TAPE)：ポリスチレン(POLYSTYRENE)
トップテープ(TOP TAPE)：PET, PE, PE
リール(REEL)：ポリスチレン(POLYSTYRENE)
- ELV及びRoHS適合品
ELV AND RoHS COMPLIANT

REVISED EC NO: J2010-1937 DRWN: YMORI 2010/03/25 CHKD: MATSUURA 2010/03/25 APPR: KMORIKAWA 2010/05/10	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2	DRAWN BY H. IJIMA	DATE 06/01/17	TITLE EMBSTP PKG FOR 0.5 FFC TO BOARD CONN RA TYPE				
		10 OVER 30 UNDER	±0.25	CHECKED BY K. TAKAHASHI	DATE 06/01/17	MOLEX INCORPORATED DOCUMENT NO. SD-501864-003 SHEET NO. 1 OF 2				
		30 OVER	±0.3	APPROVED BY H. HIRATA	DATE 06/01/17					
ANGULAR ±1 °		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. 501864-***90						
SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

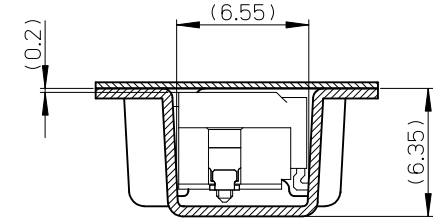
10 9 8 7 6 5 4 3 2 1



SECT. Y-Y



56mm幅キャリアテープ
56mm WIDTH CARRIER TAPE



SECT. X-X

56	57.4	25.5	33.3	501864-5090	50
キャリアテープ幅 CARRIER TAPE WIDTH	C	B	A	オーダー番号 ORDER NO.	極数 CKT

SEE SHEET 1 OF 2 EC NO: J2010-1937 DRWN: YMORI 2010/03/25 CHKD: MATSUURA 2010/03/25 APPR: KMORIKAWA 2010/05/10	DESCRIPTION REV: A	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER	± 0.2	DRAWN BY H. IJIMA	DATE 06/01/17	TITLE EMBSTP PKG FOR 0.5 FFC TO BOARD CONN RA TYPE			
		10 OVER 30 UNDER	± 0.25	CHECKED BY K. TAKAHASHI	DATE 06/01/17	MOLEX INCORPORATED			
		30 OVER	± 0.3	APPROVED BY H. HIRATA	DATE 06/01/17				
ANGULAR ± 1 °		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. 501864-**90	DOCUMENT NO. SD-501864-003	SHEET NO. 2 OF 2			